NOTES:
1. NEW IS STATIC SENSITIVE. HANDLE PER MIL-STD 883, OR EQUIVALENT.
2. SOLDERING TO BE IN ACCORDANCE WITH NASA SPECIFICATION NASA-GT-18739.2 AND NASA-GT-18739.3.
3. PARTS TO RECEIVE CURSORY VISUAL INSPECTION PRIOR TO INSTALLATION.
4. R52 NOT USED. (DO NOT INSTALL)
5. C2C (1700 pF) LAYOUT NOT CHANGED TO COAX. INSTALL "D200" (4700 pF).
6. SPACE Q's OFF P/N 1.05 PRIOR TO SOLDERING. ENSURE THE Q-CASE DOES NOT TOUCH ADJACENT COMPONENTS.
7. DO NOT INSTALL TEST HEADERS (H1-H15).
8. EPOXY ALL PLUG MOUNTED Q's TO THE BOARD USING P/N 17.
9. EPOXY LAYER TO BE AS THIN AS POSSIBLE.
10. EVENLY SPACE ALL SMD's ON PADS PRIOR TO SOLDERING.
11. IC PATTERN FOR U9 IS TOO WIDE. LEADS WERE REFORMED AT U9. ENSURE U9 ON U-PADS PRIOR TO SOLDERING.
12. ATTACH P1 TO PCB WITH SUPPLIED HARDWARE AND TORSION TO 32 IN OZ PRIOR TO SOLDERING TO PCB.